Vishay Draloric



HALOGEN

FREE

E24; E96

E24

E24; E96

E24

E24; E96

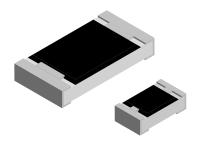
E24

1R to 1M

1R to 1M

1R to 1M

Pulse Proof, High Power Thick Film Chip Resistors



FEATURES

- · Excellent pulse load capability
- Enhanced power rating
- Double side printed resistor element
- Protective overglaze

± 100

± 200

± 100

± 200

± 100

± 200

- Pure tin solder contacts on Ni barrier layer provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

± 1

± 5

± 1

± 5

± 1

± 5

		 AEC-Q200 qualified, rev. C compliant 								
STANDARD EI	LECTF	ICAL S	PECIFICATIO	NS						
	SIZE		RATED DISSIPATION	LIMITING ELEMENT	TEMPERATURE	TOLERANCE	RESISTANCE			
MODEL	INCH	METRIC	<i>P</i> ₇₀ W	VOLTAGE U _{max.} AC/DC	COEFFICIENT ppm/K	%	RANGE Ω	SERIES		
		RR1005	0.125 ⁽¹⁾	50	± 100	± 1	1R to 1M	E24; E96		
CRCW0402-HP e3	0402		0.125 (1)		± 200	± 5	IN IO IIVI	E24		
Zero-Ohm-Resistor: $R_{\text{max.}} = 0.010 \Omega$, $I_{\text{max.}} = 3 \text{ A}$										
	0603	RR1608	0.25	75	± 100	± 1	1R to 1M	E24; E96		
CRCW0603-HP e3					± 200	± 5	TH IO TIVI	E24		
			Zero-Ohm-Resistor: $R_{\text{max.}} = 0.008 \Omega$, $I_{\text{max.}} = 5 \text{A}$							
	0805	RR2012	0.33	150	± 100	± 1	1R to 1M	E24; E96		
CRCW0805-HP e3					± 200	± 5	TH IO TIVI	E24		
			Zero-Ohm-Resistor: $R_{\text{max.}} = 0.005 \Omega$, $I_{\text{max.}} = 6 A$							
		RR3216	0.5	200	± 100	± 1	1D to 1M	E24; E96		
CRCW1206-HP e3	1206				± 200	± 5	1R to 1M	E24		
			Zero-Ohm-Resisto	r: $R_{\text{max.}} = 0.005$	Ω , $I_{\text{max.}} = 10 \text{ A}$	•	•	•		
CRCW1210-HP e3	1210	RR3225	0.75	200	± 100	± 1	1R to 1M	E24; E96		
					± 200	± 5	IN IO IIVI	E24		
			Zero-Ohm-Resisto	r: $R_{\text{max.}} = 0.004$	Ω , $I_{\text{max.}} = 12 \text{ A}$	•	•	•		
		i								

Notes

CRCW1218-HP e3

CRCW2010-HP e3

CRCW2512-HP e3

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
Marking: See document "Surface Mount Resistor Marking" (document number 20020).
Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
(1) CRCW0402-HP resistors feature a single side printed resistive layer only.

500

200

Zero-Ohm-Resistor: $R_{\text{max.}} = 0.004 \,\Omega$, $I_{\text{max.}} = 20 \,\text{A}$

Zero-Ohm-Resistor: $R_{\text{max.}} = 0.005 \,\Omega$, $I_{\text{max.}} = 12 \,\text{A}$

Zero-Ohm-Resistor: $R_{\text{max.}} = 0.005 \,\Omega$, $I_{\text{max.}} = 16 \,\text{A}$

1.5

1.0

1.5

RR3246

RR5025

RR6332

1218

2010

2512

TECHNICAL SPECIFICATIONS									
PARAMETER	UNIT	CRCW 0402-HP	CRCW 0603-HP	CRCW 0805-HP	CRCW 1206-HP	CRCW 1210-HP	CRCW 1218-HP	CRCW 2010-HP	CRCW 2512-HP
Rated dissipation P ₇₀ (2)	W	0.125	0.25	0.33	0.5	0.75	1.5	1.0	1.5
Limiting element voltage U _{max.} AC/DC	V	50	75	150	200	200	200	400	500
Insulation voltage U _{ins.} (1 min)		> 75	> 100	> 200	> 300	> 300	> 300	> 300	> 300
Insulation resistance		> 10 ⁹							
Category temperature range		- 55 to + 155							
Weight		0.65	2	5.5	10	18	31	25.5	42

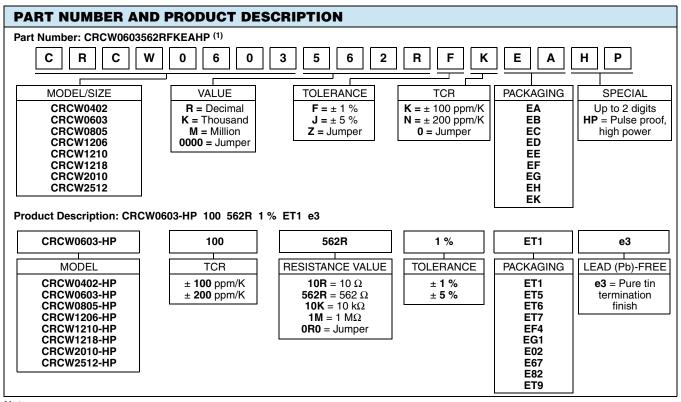
The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

Document Number: 20043 Revision: 08-Dec-10



Pulse Proof, High Power Thick Film Chip Resistors

Vishay Draloric



Note

⁽¹⁾ Preferred way for ordering products is by use of the PART NUMBER.

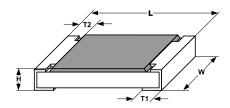
PACKAGING									
MODEL	UNIT	A	PAPER TAPE ON CC. TO IEC 60286-		BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II				
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.		
CRCW0402-HP	180 mm/7" 330 mm/13"	10 000 50 000	ED EE	ET7 EF4					
CRCW0603-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW0805-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1206-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1210-HP	180 mm/7" 285 mm/11.25" 330 mm/13"	5000 10 000 20 000	EA EB EC	ET1 ET5 ET6					
CRCW1218-HP	180 mm/7"				4000	EK	ET9		
CRCW2010-HP	180 mm/7"				4000	EF	E02		
CRCW2512-HP	180 mm/7"				2000 4000	EG EH	E67 E82		

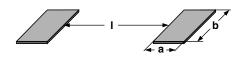
Vishay Draloric

Pulse Proof, High Power Thick Film Chip Resistors



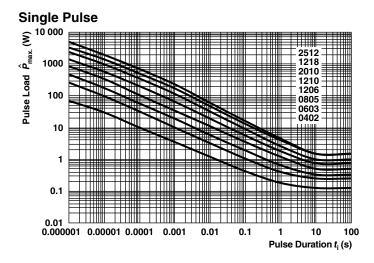
DIMENSIONS in millimeters





SIZE DIMENSIONS						SOLDER PAD DIMENSIONS						
5	olZE	DIMENSIONS				REFLO	W SOLD	ERING	WAVE SOLDERING			
INCH	METRIC	L	w	Н	T1	T2	а	b	I	а	b	I
0402	1005	1.0 ± 0.05	0.5 ± 0.05	0.3 ± 0.1	0.25 ± 0.1	0.2 ± 0.1	0.4	0.6	0.5			
0603	1608	1.6 ± 0.1	0.85 ± 0.1	0.45 ± 0.1	0.3 ± 0.2	0.3 ± 0.2	0.5	0.9	1.0	0.9	0.9	1.0
0805	2012	2.0 ± 0.15	1.25 ± 0.15	0.50 ± 0.1	0.4 ± 0.2	0.35 ± 0.2	0.7	1.3	1.2	0.9	1.3	1.3
1206	3216	3.1 ± 0.2	1.6 ± 0.15	0.50 ± 0.15	0.5 ± 0.2	0.45 ± 0.2	0.9	1.7	2.0	1.1	1.7	2.3
1210	3225	3.2 ± 0.2	2.5 ± 0.2	0.6 ± 0.1	0.45 ± 0.2	0.4 ± 0.2	0.9	2.5	2.0	1.1	2.5	2.2
1218	3246	3.1 ± 0.2	4.6 ± 0.2	0.6 ± 0.1	0.45 ± 0.2	0.4 ± 0.2	1.05	4.9	1.9	1.25	4.8	1.9
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	2.5	3.9	1.2	2.5	3.9
2512	6332	6.3 ± 0.2	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	3.2	5.2	1.2	3.2	5.2

FUNCTIONAL PERFORMANCE



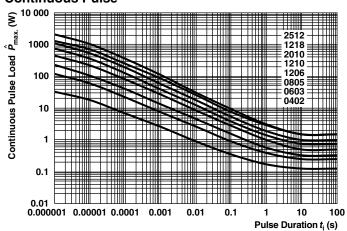
Maximum pulse load, single pulse; applicable if $\overline{P} \to 0$ and n < 1000 and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Document Number: 20043 Revision: 08-Dec-10



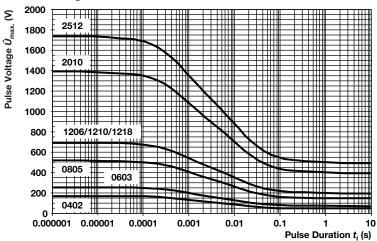
Pulse Proof, High Power Thick Film Chip Resistors





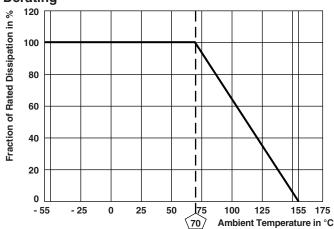
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P$ (ϑ_{amb}) and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max.}$; for permissible resistance change equivalent to 8000 h operation

Derating



Vishay Draloric

Pulse Proof, High Power Thick Film Chip Resistors



TEST PROCEDURES AND REQUIREMENTS									
EN 60115-1	IEC 60068-2 TEST	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)					
CLAUSE	AUSE METHOD			STABILITY CLASS 2 OR BETTER					
			Stability for product types:	1 Ω to 1 MΩ					
			CRCW-HP e3	1 52 to 1 10152					
4.5	-	Resistance	-	± 1 %, ± 5 %					
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	-					
4.13	-	Short time overload	$U = 2.5 \text{ x } \sqrt{P_{70} \text{ x } R}$ $\leq 2 \times U_{\text{max}}$; duration: According to style	$\pm (0.5 \% R + 0.05 \Omega)$					
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage					
7.17.2	30 (Tu)	Colderability	Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 \pm 5) °C; (3 \pm 0.3) s	Good tinning (≥ 95 % covered) no visible damage					
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K, ± 200 ppm/K					
4.32	21 (U _{U3})	Shear (adhesion)	RR 1608 and smaller: 9 N RR 2012 and larger: 45 N	No visible damage					
4.33	21 (U _{U1})	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$					
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles	± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)					
4.23	-	Dry heat	-						
4.23.2	2 (Ba)	Damp heat, cyclic	125 °C; 16 h						
4.23.3	30 (Db)	cold	55 °C; ≥ 90 % RH; 24 h; 1 cycle						
4.23.4	1 (Aa)	Low air pressure	- 55 °C; 2 h	± (2 % R + 0.1 Ω)					
4.23.5	13 (M)	-	1 kPa; (25 ± 10) °C; 1 h						
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycle						
4.23.7	-	D.C. load	$U = \sqrt{P_{70} \times R}$						
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	± (2 % R + 0.1 Ω) ± (4 % R + 0.1 Ω)					
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.5 % R + 0.05 Ω)					
4.35	-	Flammability, needle flame test	IEC 60695-15-5; 10 s	No burning after 30 s					
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R + 0.05 Ω)					
4.25.3	-	Endurance at upper category temperature	155 °C; 1000 h	± (2 % R + 0.1 Ω)					
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 positive and 3 negative discharges; ESD voltage according to size	± (1 % R + 0.05 Ω)					
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage					
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1; toothbrush	Marking legible, no visible damage					
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz; x, y, z} \le 1.5 \text{ mm;}$ $A \le 200 \text{ m/s}^2; 10 \text{ sweeps per axis}$	± (0.5 % R + 0.05 Ω)					
4.37	-	Periodic electric overload	U = √15 x P ₇₀ x R ≤ 2 x U _{max} 0.1 s "ON"; 2.5 s "OFF"; 1000 cycles	± (1 % R + 0.05 Ω)					
4.27	-	Single pulse high voltage overload, 10 μs/700 μs	$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}}$	± (1 % R + 0.05 Ω)					

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.

Document Number: 20043 Revision: 08-Dec-10



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000